

DIGISINE

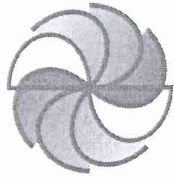
Date (22/02/2017)
TUV SUD BABT TCB
Octagon House,
Segensworth Road,
Fareham,
Hampshire,
PO15 5RL

Modular Approval Request

FCC ID: VLV101029185569

The following attestation addresses the requirements to support modular approval:

Modular approval requirement	Yes (provide brief statement)	No *
(a) The radio elements must have the radio frequency circuitry shielded. Physical components and tuning capacitor(s) may be located external to the shield, but must be on the module assembly	Yes, the external RF circuitry is shielded with RF shielding component embedded in the housing.	
(b) The module must have buffered modulation/data inputs to ensure that the device will comply with Part 15 requirements with any type of input signal	Yes, This module contains internal memory buffer for signal modulation.	
(c) The module must contain power supply regulation on the module	Yes, the module accept single LDO power input and use it internal power circuitry to adjust the signal for RF.	
(d) The module must contain a permanently attached antenna, or contain a unique antenna connector, and be marketed and operated only with specific antenna(s), per Sections 15.203, 15.204(b), 15.204(c), 15.212(a), 2.929(b)	Yes, the module is matched with the specific antenna used with the system.	
(e) The module must demonstrate compliance in a stand-alone configuration	Yes, we provide a carrier board for testing	
(f) The module must be labelled with its permanently affixed FCC ID label, or use an electronic display (See KDB Publication 784748 about labelling requirements)	Yes, the label had been permanently affixed FCC ID label on the module, please check the label.	
(g) The module must comply with all specific rules applicable to the transmitter. The grantee must provide comprehensive instructions to explain compliance requirements	Yes, the vendor provides detail circuitry and function block with commands to control the module to meet the compliance.	



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Modular approval requirement	Yes (provide brief statement)	No *
(h) The module must comply with RF exposure requirements	Yes, all RF components located outside of the module with detail information for configuration.	

* Please provide a detailed explanation if the answer is "No."

Yours sincerely,

Bibol Yuan

Name:

Bibol Yuan

Title:

Senior Engineer